VLMU3520-...-060

Vishay Semiconductors



UV SMD LED With Silicone Lens



DESCRIPTION

VLMU3520-...-060 series is a ceramic based high power UV LED with silicone lens for long life time. The package size is 3.5 mm x 3.5 mm and the radiant power up to 2 W at 1200 mA in a wavelength range of 380 nm to 410 nm.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD ceramic high power
- Product series: high power UV LED
- Angle of half intensity: ± 30°
- · Lead-finishing: Au

SAFETY ADVICES

UV LEDs emit highly concentrated, non visible UV light which can be harmful to the human eye. Do not expose the eyes or skin directly to the UV light. Wear appropriate protective gear when operating the LED. Keep out of the reach of children.

FEATURES

- Ceramic SMT package with silicone lens
- Dimension (L x W x H) in mm: 3.5 x 3.5 x 2.9
- Forward current: up to 1250 mA
- Radiant power (typ.): 900 mW at 500 mA
- Materials:
 - Die: InGaN
 - Resin: silicone (water clear)
 - Leads / terminations finish: gold plated (Au)
- · Grouping parameters:
 - Radiant power
 - Peak wavelength
 - Forward voltage
- · Reflow soldering method
- MSL2 according to J-STD-020
- Packaging: 12 mm tape on reel, Ø 180 mm (7"), 500 pcs per reel
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Industrial curing
- Photocatalytic purification
- Poster printing curing
- · Counterfeit money detector
- Blood detector
- Nail curing
- Teeth curing

| PARTS TABLE | | | | | | | | | | | | | | |
|------------------|-------------|-----------------------|------|----------------------|------|------|----------------------|------------------------|------|----------------------|------------|------|------|-------|
| PART | COLOR | RADIANT POWER (mW) | | at I _F | (nm) | | at I _F | FORWARD VOLTAGE (V) | | at I _F | TECHNOLOGY | | | |
| | | MIN. | TYP. | MAX. | (mA) | MIN. | TYP. | MAX. | (mA) | MIN. | TYP. | MAX. | (mA) | |
| VLMU3520-385-060 | Ultraviolet | 740 | 900 | - | 500 | 380 | 385 | 390 | 500 | 3.2 | 3.6 | 4.0 | 500 | InGaN |
| VLMU3520-395-060 | Ultraviolet | 740 | 900 | - | 500 | 390 | 395 | 400 | 500 | 3.2 | 3.6 | 4.0 | 500 | InGaN |
| VLMU3520-405-060 | Ultraviolet | 740 | 900 | - | 500 | 400 | 405 | 410 | 500 | 3.2 | 3.6 | 4.0 | 500 | InGaN |



GREEN

(5-2008)



| ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) VLMU3520060 | | | | | | |
|--|-------------------------------------|-------------------|-------------|------|--|--|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT | | |
| DC forward current | | ۱ _F | 1250 | mA | | |
| Pulse forward current | Duty cycle 1/10, pulse width 0.1 ms | I _{FP} | 1500 | mA | | |
| Power dissipation | | Pv | 5 | W | | |
| Electrostatic discharge | HBM: MIL-STD-883 C 3B | ESD | 8000 | V | | |
| Junction temperature | | Тj | +130 | °C | | |
| Operating temperature range | | T _{amb} | -40 to +105 | °C | | |
| Storage temperature range | | T _{stg} | -40 to +105 | °C | | |
| Solder temperature | | T _{sol} | 260 | °C | | |
| Thermal resistance - junction to solder point | | R _{thJS} | 10 | K/W | | |

OPTICAL AND ELECTRICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified) **VLMU3520-...-060, ULTRAVIOLET**

| PARAMETER | TEST CONDITION | DEVICE TYPE | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|---|--------------------------|------------------|-----------------------|------|------|------|------|
| Forward voltage | I _F = 500 mA | | V _F | 3.2 | 3.6 | 4 | V |
| Radiant power | I _F = 500 mA | VLMU3520060 | фе | 740 | 900 | - | mW |
| Radiant power | I _F = 1200 mA | VLMU3520060 | фе | - | 2000 | - | mW |
| Ratio of radiant intensity / radiant power | I _F = 500 mA | VLMU3520060 | I_e/Φ_e | - | 0.63 | - | sr-1 |
| | I _F = 500 mA | VLMU3520-385-060 | λ _p | 380 | 385 | 390 | nm |
| Peak wavelength | | VLMU3520-395-060 | | 390 | 395 | 400 | nm |
| | | VLMU3520-405-060 | | 400 | 405 | 410 | nm |
| | | VLMU3520-385-060 | | - | 13 | - | nm |
| Spectral bandwidth at 50 % $\Phi_{\rm rel.}$ max. | I _F = 500 mA | VLMU3520-395-060 | $\Delta\lambda_{0.5}$ | - | 15 | - | nm |
| | | VLMU3520-405-060 | | - | 18 | - | nm |
| Angle of half intensity | I _F = 500 mA | | φ | - | ± 30 | - | 0 |
| Reverse current | V _R = 5 V | | I _R | - | - | 10 | μA |

Note

- Tolerances: \pm 11 % for $\phi_e,$ \pm 0.1 V for V_F, \pm 1 nm for λ_p

| RADIANT POWER CLASSIFICATION ($I_F = 500 \text{ mA}$) | | | | | | |
|--|------|------|------|--|--|--|
| GROUP | MIN. | MAX. | UNIT | | | |
| U074 | 740 | 780 | | | | |
| U078 | 780 | 820 | | | | |
| U082 | 820 | 860 | | | | |
| U086 | 860 | 900 | mW | | | |
| U090 | 900 | 940 | | | | |
| U094 | 940 | 980 | | | | |
| U098 | 980 | 1020 | | | | |

| PEAK WAVELENGTH CLASSIFICATION ($I_F = 500 \text{ mA}$) | | | | | | |
|--|------|------|------|--|--|--|
| GROUP | MIN. | MAX. | UNIT | | | |
| Q380 | 380 | 385 | | | | |
| Q385 | 385 | 390 | | | | |
| Q390 | 390 | 395 | | | | |
| Q395 | 395 | 400 | nm | | | |
| Q400 | 400 | 405 | | | | |
| Q405 | 405 | 410 | | | | |



| FORWARD VOLTAGE CLASSIFICATION ($I_F = 500 \text{ mA}$) | | | | | | |
|---|------|------|------|--|--|--|
| GROUP | MIN. | MAX. | UNIT | | | |
| V3234 | 3.2 | 3.4 | | | | |
| V3436 | 3.4 | 3.6 | N/ | | | |
| V3638 | 3.6 | 3.8 | v | | | |
| V3840 | 3.8 | 4.0 | | | | |

Note

• In order to ensure availability, single groups for radiant intensity, wavelength, and forward voltage will not be orderable. Only one group for radiant intensity, wavelength, and forward voltage will be shipped in any one reel

MARKING EXAMPLE FOR SELECTION CODE ON LABEL

Selection code: U090Q385V3436

- U090: $\phi_{e},$ range 900 mW to 940 mW
- Q385: λ_p , range 385 nm to 390 nm
- V3436: V_F, range 3.4 V to 3.6 V



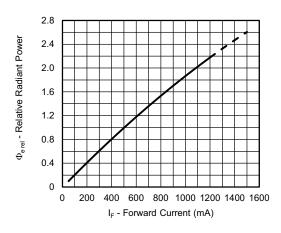


Fig. 1 - Relative Radiant Power vs. Forward Current

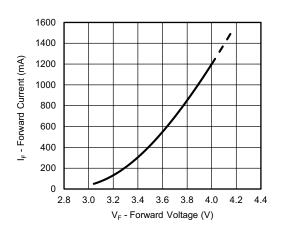


Fig. 2 - Forward Current vs. Forward Voltage

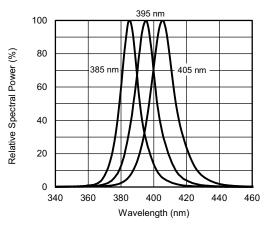


Fig. 3 - Relative Spectral Power vs. Wavelength

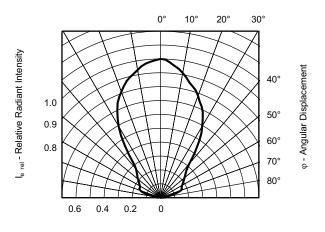
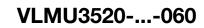
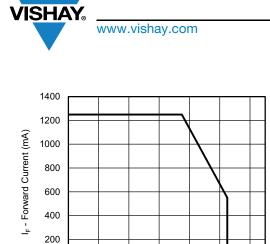


Fig. 4 - Relative Radiant Intensity vs. Angular Displacement





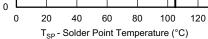


Fig. 5 - Maximum Forward Current vs. Solder Point Temperature

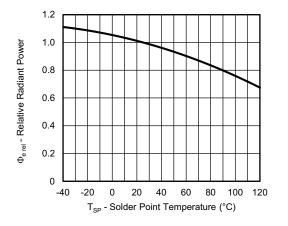


Fig. 6 - Relative Radiant Power vs. Solder Point Temperature

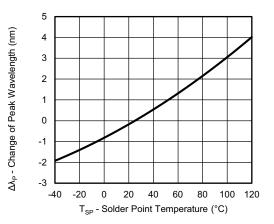


Fig. 7 - Change of Peak Wavelength vs. Solder Point Temperature

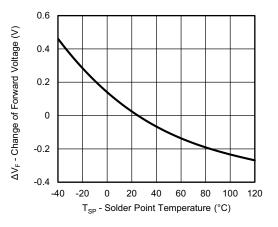
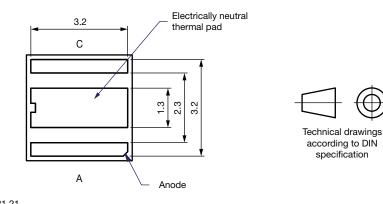


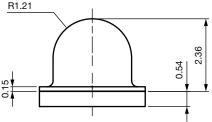
Fig. 8 - Change of Forward Voltage vs. Solder Point Temperature

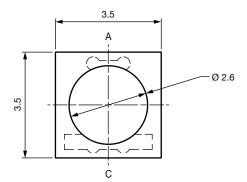
4



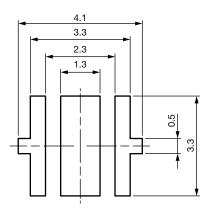
PACKAGE DIMENSIONS in millimeters





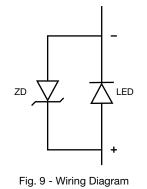


Drawing-No.: 6.541-5108.02-4 Issue: 1VK; 01.10.2020 Recommended solder pad footprint



Not indicated tolerances ± 0.13

WIRING



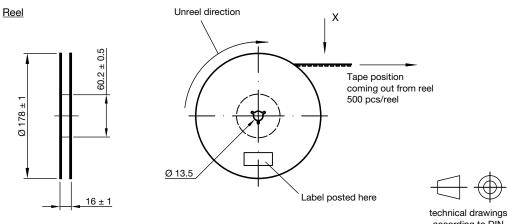
5

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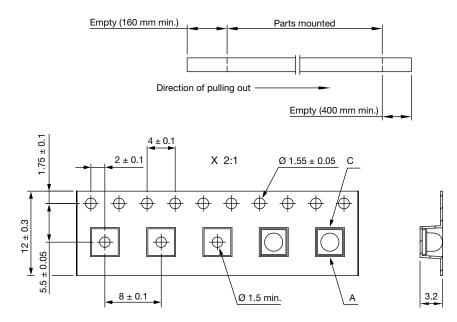
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Leader and trailer tape



Drawing-No.: 9.800-5131.01-4 Issue: 2; 04.03.20

VLMU3520-...-060



HANDLING RECOMMENDATIONS

In order to achieve excellent lifetime, the package of these UV-LEDs consists of a ceramic substrate in combination with a UV stable silicone as lens material. Compared to standard materials silicone is generally softer and it tends more to attract dust:

- Minimize the level of dirt and dust particles in contact with the LED
- Small amounts of particles on the LEDs, although noticeable from a cosmetic point of view, do not affect the performance in terms of brightness, reliability and quality
- If cleaning is required, a short rinsing with isopropyl alcohol, not longer than 15 seconds, is recommended. Do not use ultrasonic cleaning, it may damage the LED
- Do not apply mechanical stress on the silicone lens
- Avoid any piercing of the silicone lens by sharp objects
- It is recommended to use a suitable pick and place tool for the removal of the LED from blister tape without applying stress to the lens. The recess of the pick-up needle has to be larger than the silicone lens
- For manual handling using tweezers make sure that the LED will be touched carefully at the sidewall of the ceramic substrate, but not at the silicone lens

SOLDERING PROFILE

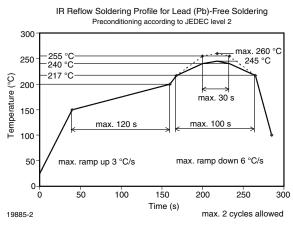
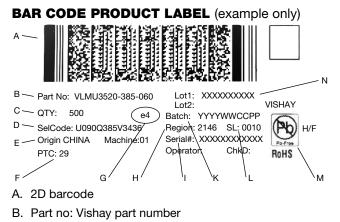


Fig. 10 - Vishay Lead (Pb)-free Reflow Soldering Profile (according to J-STD-020C)

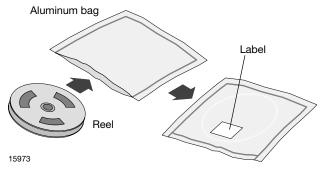
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- C. QTY: quantity
- D. SelCode: selection bin code
- E. Country of origin
- F. PTC: production plant code
- G. Termination finish
- H. Region code
- I. Serial#: serial number
- K. Batch number: year, week, country code, plant code
- L. SL: sales location
- M. Environmental symbols: RoHS, lead (Pb)-free, halogen free
- N. Lot numbers

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

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RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

After more than 1 year under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

24 h at 60 $^{\circ}\text{C}$ + 5 $^{\circ}\text{C}$ and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC[®] standard JESD22-A112 level 2 label is included on all dry bags.

CAUTION This bag contains MOISTURE-SENSITIVE DEVICES LEVEL 1. Shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH).</td> 1. 2. After this bag is opened, devices that will be subjected to infrared reflow, vapor-phase reflow, or equivalent processing (peak package body temp. 220°C) must be: a) a) Mounted within 1 year at factory conditions of ≤ 30°C/60% RH or b) b) Stored at ≤ 20% RH. c) c) Devices require baking, before mounting, if: a) a) Humidity Indicator Card is >20% when read at 23°C ± 5°C, or b) 2. a or 2b is not met. c) 4. If baking is required, devices may be baked for: a) a) 192 hours at 40°C + 5°C/o°C and <5% RH</td> Bag Seal Date: [If blank, see bar code label] Note: LEVEL defined by EIA JEDEC Standard JESD22-A112 170282

Example of JESD22-A112 level 2 label

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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